<u>SENSITRON</u> SEMICONDUCTOR

400

130

40

0.90

-55 to

+200

I_{FSM}

Ст

Pd

 $R_{\theta JC}$

Top, Tstg

Amps

pF

W

°C/W

°C

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HERMETIC SILICON CARBIDE RECTIFIER

DESCRIPTION: A 1200-VOLT, 20 AMP POWER SILICON CARBIDE RECTIFIER IN A CERAMIC HERMETIC SHD-3 HIGH PROFILE PACKAGE

FEATURES:

 $(t = 10\mu s, pulse)$

NO RECOVERY TIME OR REVERSE RECOVERY LOSSES

MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

MAXIMUM JUNCTION CAPACITANCE ($V_r = 400V$)

MAXIMUM THERMAL RESISTANCE (Junction to Case)

MAXIMUM OPERATING AND STORAGE TEMPERATURE RANGE

• NO TEMPERATURE INFLUENCE ON SWITCHING BEHAVIOR

MAXIMUM RATINGS ALL RATINGS ARE @ T_C = 25 °C UNLESS OTHERWISE SPECIFIED. UNITS RATING SYMBOL MAX. PEAK INVERSE VOLTAGE PIV 1200 Volts MAXIMUM DC OUTPUT CURRENT Ь 20 Amps MAXIMUM REPETITIVE FORWARD SURGE CURRENT 80 Amps IFRM (t = 8.3 ms, Sine)

ELECTRICAL CHARACTERISTICS	

MAXIMUM POWER DISSIPATION

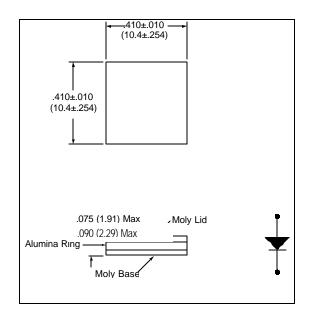
CHARACTERISTIC	ТҮР	MAX.	UNITS
MAXIMUM FORWARD VOLTAGE DROP I _f = 20 A, T_J =25 °C	1.60	1.80	
T _J =175 °C	2.50	3.00	Volts
MAXIMUM REVERSE CURRENT PIV = 1200V, $T_J = 25 \text{ °C}$	0.02	0.40	
T _J = 175 °C	0.04	2.00	mA
TOTAL CAPACITIVE CHARGE (V $_R$ =1200V, I_F =20A, di/dt=500A/ μs and T_J=25°C) Q_C	100	N/A	nC

SENSITRON

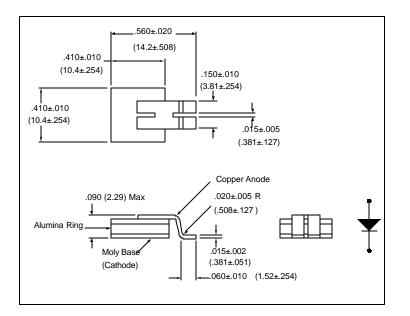
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SHD-3 (High Profile)







Application Note: Customers should be aware that at the current stage of technical development of SiC, the reverse avalanche capabilities of the device are limited.

Customer designs will need to accommodate these limitations and avoid exposure of the device to this and other potentially damaging conditions in their applications.



TECHNICAL DATA

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